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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Product Specification

RoHS-6 Compliant 10Gb/s 850nm Multimode Datacom XFP Optical Transceiver FTLX8512D3BCL

PRODUCT FEATURES

- Hot-pluggable XFP footprint
- Supports 8.5Gb/s to 10.5Gb/s* bit rates
- Power dissipation <1.5W
- RoHS-6 compliant (lead-free)
- Temperature range -5°C to 70°C
- Single power supply: 3.3V
- Maximum link length of 300m
- Uncooled 850nm VCSEL laser.
- Duplex LC connector
- No Reference Clock required
- Built-in digital diagnostic functions
- Standard bail release mechanism



APPLICATIONS

- 10GBASE-SR/SW 10G Ethernet
- 1200-Mx-SN-I 10G Fibre Channel
- 800-SM-LC-L 8G Fibre Channel

Finisar's FTLX8512D3BCL Small Form Factor 10Gb/s (XFP) transceivers are compliant with the current XFP Multi-Source Agreement (MSA) Specification¹. They comply with 10-Gigabit Ethernet 10GBASE-SR/SW per IEEE 802.3ae, 10G Fibre Channel 1200-Mx-SN-I and 8G Fibre Channel 800SM-LC-L. Digital diagnostics functions are available via a 2-wire serial interface, as specified in the XFP MSA. The optical transceiver is compliant per the RoHS Directive 2011/65/EU³. See Finisar Application Note AN-2038 for more details⁴.

PRODUCT SELECTION

FTLX8512D3BCL

^{*}Contact Finisar for higher data rate support.



I. Pin Descriptions

Pin	Logic	Symbol	Name/Description			
1		GND	Module Ground			
2		VEE5	Optional –5.2 Power Supply – Not required			
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to			
			respond to 2-wire serial interface commands			
4	LVTTL-O	I	Interrupt (bar); Indicates presence of an important condition	2		
		Interrupt	which can be read over the serial 2-wire interface			
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off			
6		VCC5	+5 Power Supply – Not required			
7		GND	Module Ground	1		
8		VCC3	+3.3V Power Supply			
9		VCC3	+3.3V Power Supply			
10	LVTTL-I	SCL	Serial 2-wire interface clock	2		
11	LVTTL-	SDA	Serial 2-wire interface data line	2		
	I/O					
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded	2		
			in the module.			
13	LVTTL-O	Mod_NR	Module Not Ready; Finisar defines it as a logical OR	2		
			between RX_LOS and Loss of Lock in TX/RX.			
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2		
15		GND	Module Ground	1		
16		GND	Module Ground	1		
17	CML-O	RD-	Receiver inverted data output			
18	CML-O	RD+	Receiver non-inverted data output			
19		GND	Module Ground	1		
20		VCC2	+1.8V Power Supply – Not required			
21	LVTTL-I	P_Down/RST	Power Down; When high, places the module in the low			
			power stand-by mode and on the falling edge of P_Down			
			initiates a module reset			
			Reset; The falling edge initiates a complete reset of the			
			module including the 2-wire serial interface, equivalent to a			
			power cycle.			
22		VCC2	+1.8V Power Supply – Not required			
23	PD 65	GND	Module Ground	1		
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the	3		
			host board – Not required	_		
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host	3		
			board – Not required			
26		GND	Module Ground	1		
27		GND	Module Ground	1		
28	CML-I	TD-	Transmitter inverted data input			
29	CML-I	TD+	Transmitter non-inverted data input			
30		GND	Module Ground	1		

Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector; should be pulled up with $4.7k\Omega 10k\Omega$ on host board to a voltage between 3.15V and 3.6V.
- 3. A Reference Clock input is not required by the FTLX8512D3BCL. If present, it will be ignored.



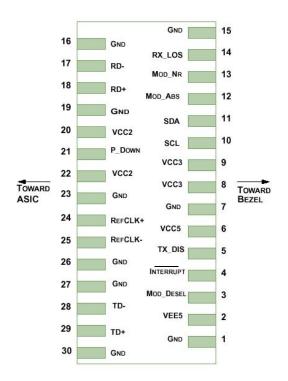


Diagram of Host Board Connector Block Pin Numbers and Name

II. Absolute Maximum Ratings

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Maximum Supply Voltage	Vcc3	-0.5		4.0	V	
Storage Temperature	T_{S}	-40		85	°C	
Case Operating Temperature	T_{OP}	-5		70	°C	



III. Electrical Characteristics ($T_{OP} = -5 \text{ to } 70 \text{ °C}$, $V_{CC3} = 3.13 \text{ to } 3.45 \text{ Volts}$)

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Supply Voltage	Vcc3	3.13		3.45	V	
Supply Current	Icc3			400	mA	
Module total power	P		1.0	1.5	W	1
Transmitter						
Input differential impedance	R _{in}		100		Ω	2
Differential data input swing	Vin,pp	120		1000	mV	
Transmit Disable Voltage	V_{D}	2.0		Vcc	V	3
Transmit Enable Voltage	V_{EN}	GND		GND+ 0.8	V	
Transmit Disable Assert Time				10	us	
Receiver						
Differential data output swing	Vout,pp	340		850	mV	4
Data output rise time	$t_{\rm r}$			40	ps	5
Data output fall time	t_{f}			40	ps	5
LOS Fault	$V_{LOS\ fault}$	Vcc-0.5		Vcc_{HOST}	V	6
LOS Normal	V _{LOS norm}	GND	<u>'</u>	GND+0.5	V	6
Power Supply Rejection	PSR		See Note	e 6 below		7

Notes:

- 1. Maximum total power value is specified across the full temperature and voltage range.
- 2. After internal AC coupling.
- 3. Or open circuit.
- 4. Into 100 ohms differential termination.
- 5. 20 80 %.
- 6. Loss Of Signal is open collector to be pulled up with a $4.7k\Omega 10k\Omega$ resistor to 3.15 3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 7. Per Section 2.7.1. in the XFP MSA Specification¹.



Optical Characteristics (T_{OP} = -5 to 70 °C, V_{CC3} = 3.13 to 3.45 Volts) IV.

Parameter	Symbol	Min	Тур	Max	Unit	Ref.
Transmitter						
Optical Modulation Amplitude	P_{OMA}	-2.8	-1.5		dBm	
(OMA)						
Average Optical Power	P_{AVE}	-5.0		-1.0		1
Optical Wavelength	λ	840	850	860	nm	
RMS Spectral Width	$\Delta \lambda_{ m rms}$		0.4	0.45	dB	
Optical Extinction Ratio	ER	3.0	5.5		dB	
Transmitter and Dispersion Penalty	TDP			3.9	dB	
Average Launch power of OFF	P_{OFF}			-30	dBm	
transmitter			Per 802.3ae			
Tx Jitter	Tx_j					
Encircled Flux	<4.5μm			30	%	2
	<19µm	86			70	2
Relative Intensity Noise	RIN ₁₂ OMA			-128	dB/Hz	
Receiver						
Receiver Sensitivity (OMA)	R _{SENS1}			-11.1	dBm	3
@ 10.5Gb/s						3
Stressed Receiver Sensitivity	R _{SENS2}			-7.5	dBm	4
(OMA) @ 10.3Gb/s						7
Maximum Input Power	P_{MAX}	+0.5			dBm	
Wavelength Range	$\lambda_{ m C}$	840		860	nm	
Receiver Reflectance	R_{rx}			-12	dB	
LOS De-Assert	LOS_D	-30			dBm	
LOS Assert	LOS_A		-20	-12	dBm	
LOS Hysteresis		0.5			dB	

Notes:

- 1. Average power figures are informative only, per IEEE 802.3ae.
- Measured into Type A1a (50/125 μm multimode) fiber per ANSI/TIA/EIA-455-203-2.
 Measured with worst ER; BER<10⁻¹²; 2³¹ 1 PRBS.
- 4. Per IEEE 802.3ae.



V. General Specifications

Para	Symbol	Min	Тур	Max	Units	Ref.	
Bit Rate		BR	8.5		10.5	Gb/s	1
Bit Error Ratio		BER			10 ⁻¹²		2
Maximum Suppor	rted Distances						
Fiber Type	850nm OFL Bandwidth						
	160MHz-km				26		
62.5µm	OM1 200MHz-km	Lmax			33	m	
	400MHz-km				66		
50μm	OM2 500MHz-km	Lmax			82	m	
	OM3 2000MHz-km				300		

- 800-SM-LC-L, 10GBASE-SR/SW, 1200-Mx-SN-I
 Tested with a 2³¹ 1 PRBS

VI. **Environmental Specifications**

Finisar XFP transceivers have an operating temperature range from -5°C to +70°C case temperature.

Parameter	Symbol	Min	Тур	Max	Units	Ref.
Case Operating Temperature	T_{op}	-5		70	°C	
Storage Temperature	T_{sto}	-40		85	°C	

Regulatory Compliance

Finisar XFP transceivers are Class 1 Laser Products. They are certified per the following standards:

Feature	Agency	Standard	Certificate Number
Laser Eye Safety	FDA/CDRH	CDRH 21 CFR 1040 and Laser Notice 50	9210176-77
Laser Eye Safety	TÜV	EN60825	R7201686
Electrical Safety	TÜV	EN 60950	R7201686
Electrical Safety	UL/CSA	CLASS 3862.07 CLASS 3862.87	2283290

Copies of the referenced certificates will be available at Finisar Corporation upon request.



VIII. Digital Diagnostic Functions

As defined by the XFP MSA¹, Finisar XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- Transceiver temperature
- Laser bias current
- Transmitted optical power
- Received optical power
- Transceiver supply voltage

It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

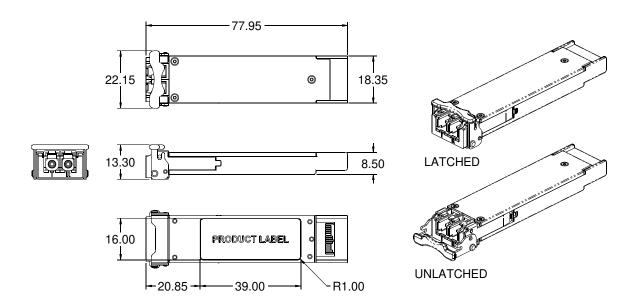
The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

For more detailed information including memory map definitions, please see Finisar Application Note AN-2035 "Digital Diagnostic Monitoring Interface for XFP Optical Transceivers", or the XFP MSA Specification¹.



IX. Mechanical Specifications

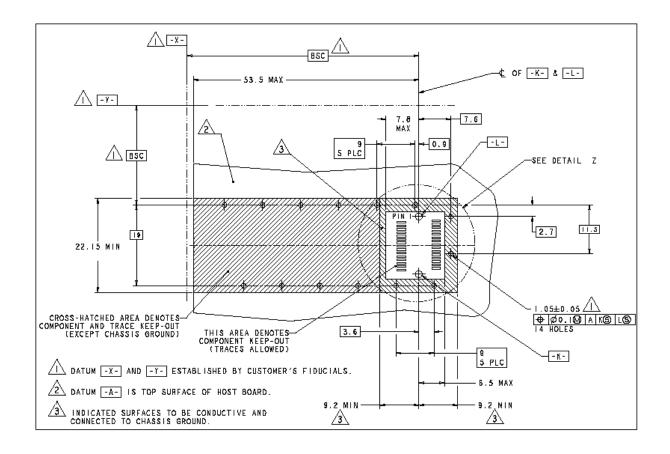
Finisar's XFP transceivers are compliant with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA). Bail color is beige.



XFP Transceiver (dimensions are in mm)

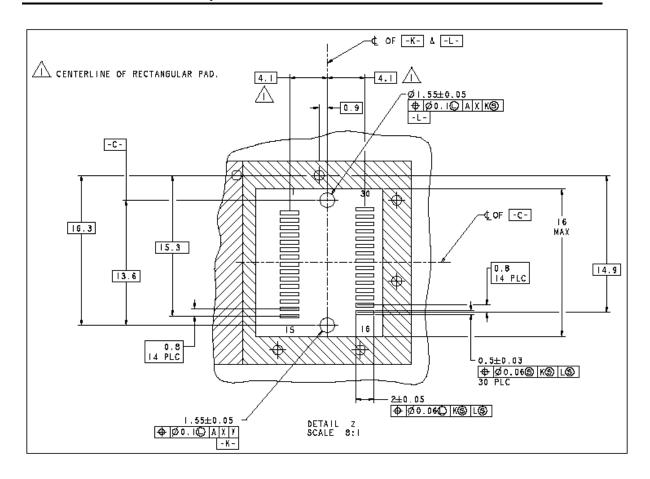


X. PCB Layout and Bezel Recommendations

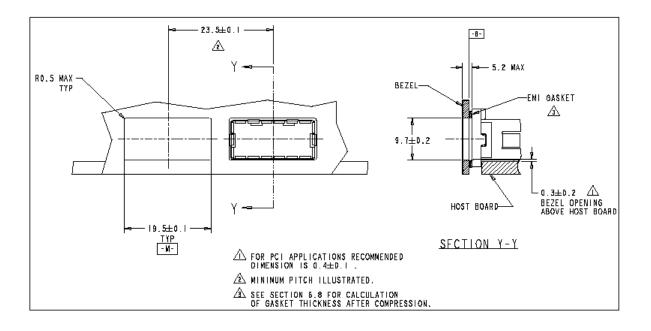


XFP Host Board Mechanical Layout (dimensions are in mm)





XFP Detail Host Board Mechanical Layout (dimensions are in mm)



XFP Recommended Bezel Design (dimensions are in mm)



XI. References

- 1. 10 Gigabit Small Form Factor Pluggable Module (XFP) Multi-Source Agreement (MSA), Rev 4.5 August 2005. Documentation is currently available at http://www.xfpmsa.org/
- 2. Application Note AN-2035: "Digital Diagnostic Monitoring Interface for XFP Optical Transceivers" Finisar Corporation, December 2003
- 3. Directive 2011/65/EU of the European Council Parliament and of the Council, "on the restriction of the use of certain hazardous substances in electrical and electronic equipment"
- 4. "Application Note AN-2038: Finisar Implementation Of RoHS Compliant Transceivers"

XII. For More Information

Finisar Corporation 1389 Moffett Park Drive Sunnyvale, CA 94089-1133 Tel. 1-408-548-1000 Fax 1-408-541-6138 sales@finisar.com www.finisar.com